#### IQC 檢驗重點

料號

10HB3-714064-30R

品名規格

GDDR5 H5GQ2H24AFR-T2C HYNIX SMD FBGA170 64M\*32 2GB

#### 零件樣品圖:





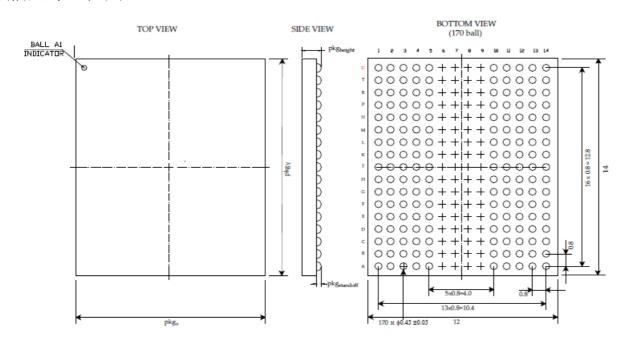
#### 外觀文字面檢驗重點:

- 1. HYNIX: Company Logo (不可變)
- 2. H5GQ2H24AFR T2C : Part number (不可變)
- 3. 202A: Date code (可變)
- 4. VWLK0018DC: Lot Number (可變)
- 5. ●: PIN1(不可變)

Hynix內部因股權結構變化,公司Logo變更為SKhynix, 現加入SKhynix列入IQC檢驗允收規範(附廠商名稱變更 說明)。

注: 變更前後兩種Logo均列入允收範圍

#### 機構尺寸工程圖:



#### IQC電氣、機構檢驗重點:

- 1. 量測各部尺寸須與規格值相符.
- 2. 檢視產品外觀,表面無異物,且不得有任何破損及變形.

 $\mu$  -EDX 需依照HCSR 有害物質管制規範實施檢測,並參照FP-0743-05-03 IQC EDX Test Guide 規範。

Date: 2012/04/16	Rev. 00	首次發行
Date: 2013/03/19	Rev. 01	新增文字面廠商Logo說明





## Process Change Notification

o ITEM : SK hynix Cl(Corporate Identity) Change,

from hynix to SK hynix.

o PRODUCT : ALL

Date Issued : Apr. 10, 2012

Issued by :

CH Lee V.P / QRA

Tel : 82-31-639-9164

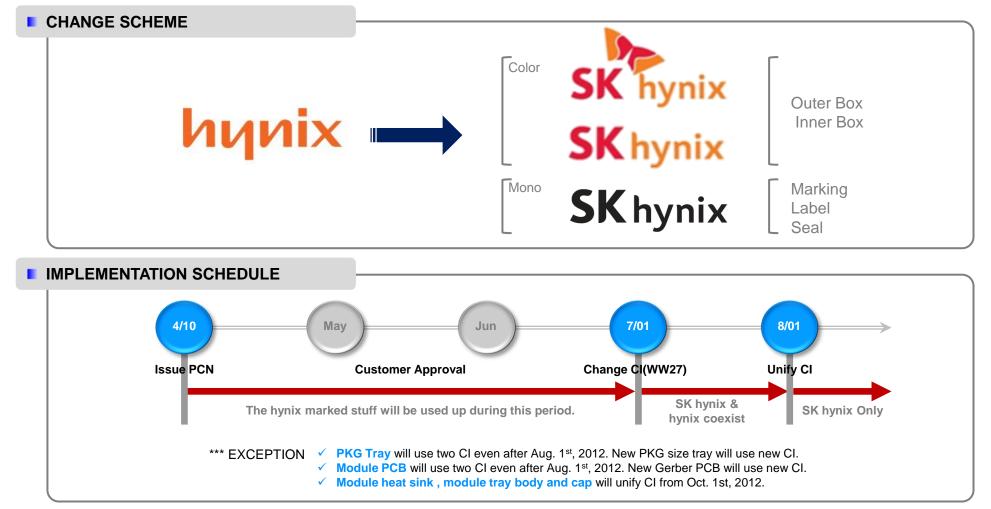
E-mail: cheolho.lee@skhynix.com

SK hynix Inc.	Process Chang	e Notification	PCN #: H-12-0ALL-AL-P-003 Date : Apr. 10, 2012
1. Customer: All Customers		2. Device : All	
3. Title : SK hynix CI(Corporate	Identity) Change, from hynix to SK	hynix.	
4. Purpose		5. Description	
To implement new CI(corporate identity) of SK hynix on all devices and stuff which have old hynix CI.		below.  Changed groups: Componer Others.  From July 1st, 2012(WW27) independent steps.	anged from hynix to SK hynix as  nt, Module, Packing Material, Label,  new CI will be used from  ist. From August 1st, CI will be
6. Effective Date		7. Evaluation Results & Schee	dule : Appendix ( No, Yes)
Jul. 01, 2012 (Date Code : WW2	7~)		
Remarks :			



SK hynix would like to receive feedback from our customers about new CI(corporate identity) scheme.

#### From August 1st, SK hynix CI will be unified as new one.





## **Major Changed Category**

CATEGORY	ITEMS
Component	Top marking
Module	<ul><li>Heat sink</li><li>PCB</li></ul>
Packing material	<ul><li>Component Al-Bag</li><li>Inner Box</li><li>Outer Box</li></ul>
Label	<ul> <li>Inner Box Label</li> <li>2D Barcode Information</li> <li>Customer Label</li> <li>Outer Box Customer Label</li> <li>IPK Module Label</li> <li>Module Normal Label</li> <li>mSATA Label</li> <li>Standard SSD Label</li> <li>Container Box</li> </ul>
Others	<ul> <li>Seal ( Component, Module, QA)</li> <li>Hynix Label</li> <li>Numonyx (Micron) Label</li> <li>Quality certificate</li> <li>Invoice document</li> <li>Packing list</li> <li>출하 검사 성적서</li> <li>Shipping list</li> </ul>



# **Appendix**



## Component

Customer : All	Item : Top Side Marking
OLD	NEW
hириіх	SKhynix
Example    Liquix	SKhynix H5GQ2H24AFR ROC 214A  • ₩ULK0030CA4
Old type Description : hynix	New type Description: SK hynix



#### Module

Customer : All	Item : Heat Sink
OLD	NEW
hииix	<b>SK</b> hynix
R1216298P R1216298P R1216298P	Example  R1216293P  SK hynix R1216293P
Old type Description: hynix	New type Description : SK hynix



#### Module

Customer: All Item: All Module PCB OLD **NEW и**ииіх **SK** hynix Example Example Color will be same with "KOREA". Old type Description: hynix New type Description: SK hynix



## **Packing material**

Customer : All	Item : Component Al-Bag
OLD	NEW
hynix	SK hynix
Example	Example
CAUTION  B. ET CONCENT  B. Many products  C. C	Caution  Not beginners  State Point State  Country  Country  Not beginners  Not b
Old type Description: hynix	New type Description: SK hynix



## **Packing material**

Customer : All	Item : Inner Box
OLD	NEW
hииix	SK hynix
Example	Example
Semiconductor 70G  Semiconductor 90  F  E  110  August 2  350	30
Old type Description: hynix	New type Description: SK hynix



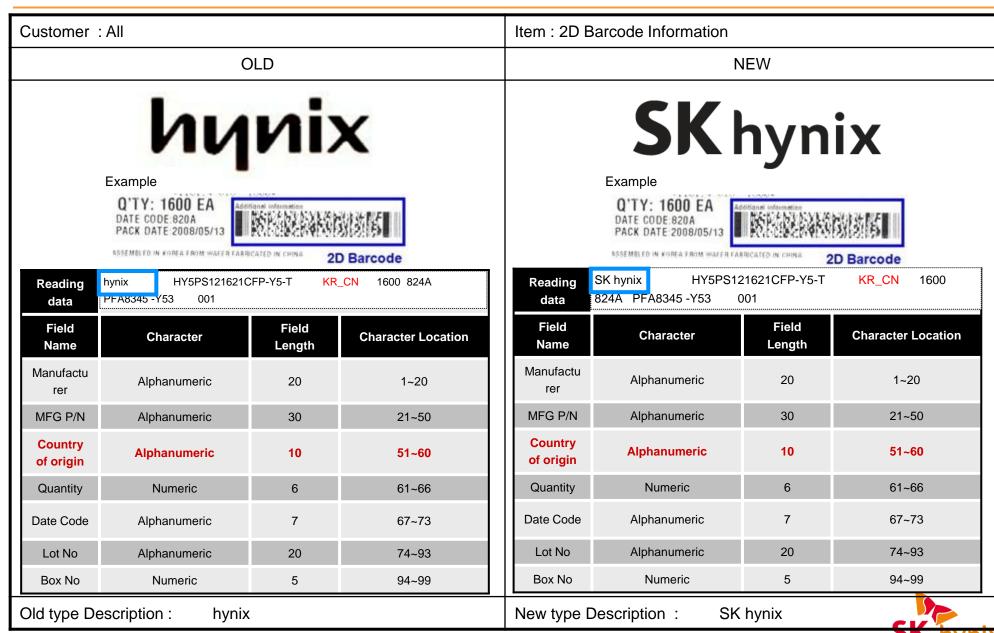
## **Packing material**

Customer : All	Item : Outer Box (@Wafer Only)
OLD	NEW
hииix	CHANGE ITEMS  a. Deletion of "hynix Semiconductor"  b. Changed box color from white to gray
Example	Example
Old type Description : hynix	New type Description: SK hynix



Customer : All	Item : Inner Box Label
OLD	NEW
hириіх	SKhynix
SUPPLIER: hynix  DEVICE :H270CG8UDBI LOT NO. :1VK211800	SUPPLIER: SK hynix  DEVICE :H270CG8UDB LOT NO. :1VK211800
Old type Description: hynix	New type Description: SK hynix





ustomer : All	Item : Inner Box Customer Label	
OLD	NEW	
hyиix	SKhynix	
Example	Example	
P/N: 335S0738  (M)Mfr P/N: H27UCG8UDAYR-BCR  (Q)QTY: 2000 PCS (D)Date Code: 049A  (L)LotNo: 1QJ8307AQ  Supplier: hynix COO: KOREA WAFER COO: KOREA	P/N: 335S0738  (7) Mfr P/N: H27UCGBUDAYR-BCR  (Q) DTY: 2000 PCS (D) Date Code: 849A  (L) Lotho: 1QJ8307AQ  Supplier: SKhynix C JO: KOREA WAFER COO: KOREA	
type Description : hynix	New type Description: SK hynix	



Customer: All	Item : Outer Box Customer Label
OLD	NEW
hириіх	<b>SK</b> hynix
(P) APN: 335S0872  (M) Mfr P/N: H2JTEG8VD1MBR – BC  (Q) QTY: 1,000 PCS  (D) D/C: D205T  Supplier: Hynix	(P) APN: 335S0872  (M) Mfr P/N: H2JTEG8VD1MBR – BC  (Q) QTY: 1,000 PCS  (D) D/C: D205T  Supplier: SK hynix
Old type Description : hynix	New type Description: SK hynix



Customer : All	Item : IPK Module Label
OLD	NEW
hynix	SKhynix
ASSEMBLED IN KOREA FROM WAFER FABRICATED FROM WAFER	ASSEMBLED IN KOREA  SUPPLIER: SK hynix  DEVICE: HMT325U6CFR8C - H9N0 ITEM: 115895 - A28 O'TY: 50 EA (Q.A) BATCH: AA - 3A1CAA04 - TAWI - 1830 DATE CODE: 1213 (03/28) LOT NO: TD23N87202 - 09 (1 / 12)  (INNER BOX)  ASSEMBLED IN KOREA FROM WAFER FABRICATED IN KOREA FROM WAFER FABRIC
Old type Description: hynix	New type Description: SK hynix

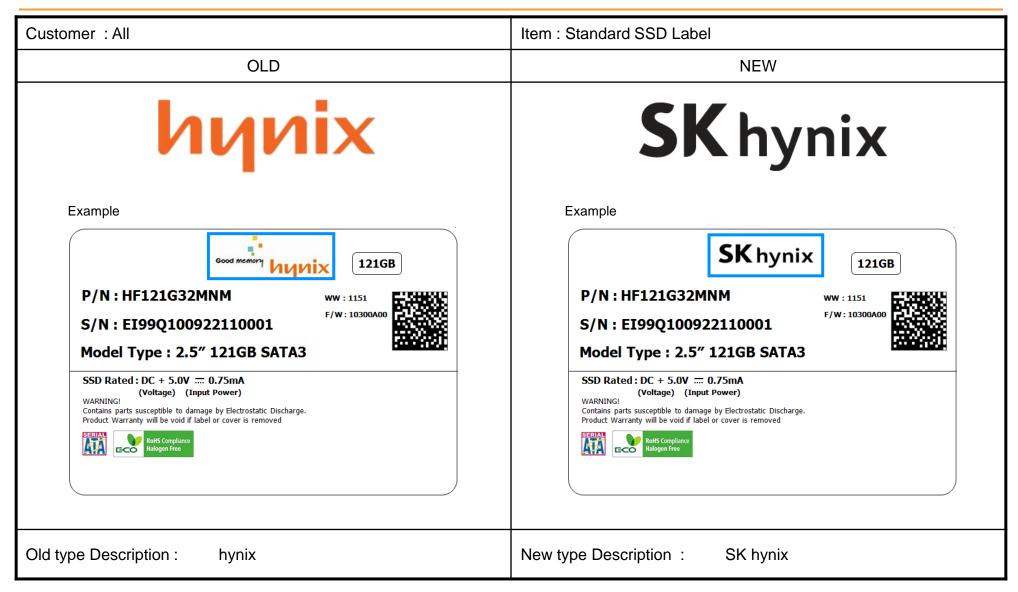


Customer : All	Item : Module Normal Label
OLD	NEW
hииix	SKhynix
Example    Munix   2GB 1Rx8 PC3 - 10600U - 9 - 10 - A0	SK hynix 2GB 1Rx8 PC3 – 10600U – 9 – 10 – A0  KOREA 03  HMT325U6BFR8C – H9 N0 AA 1145
Old type Description: hynix	New type Description: SK hynix



Customer : All	Item: mSATA Label
OLD	NEW
hииix	SKhynix
Example	Example
P/N: HF120GAMNM  S/N: EI99Q100922110001  SSD Rate: DC + 3.3V 1A FW: 10200A00  Density: 120GB WW: 1202  Warranty Void If Label Removed or Damaged	P/N: HF120GAMNM S/N: El99Q100922110001  SSD Rate: DC + 3.3V 1A FW: 10200A00 Density: 120GB WW: 1202 Warranty Void If Label Removed or Damaged
Old type Description : hynix	New type Description : SK hynix







Customer : All	Item : Container Box
OLD	NEW
hyиix	SKhynix
Example	Example
SUPPLIER : Hynix DEVICE : YACD5B1SBDBS-A10B LOT NO : 8MK2100 (1/2)	SUPPLIER SK hynix  DEVICE : YACD5B1SBDBS-A10B  LOT NO : 8MK2100 (1/2)
Old type Description : hynix	New type Description: SK hynix

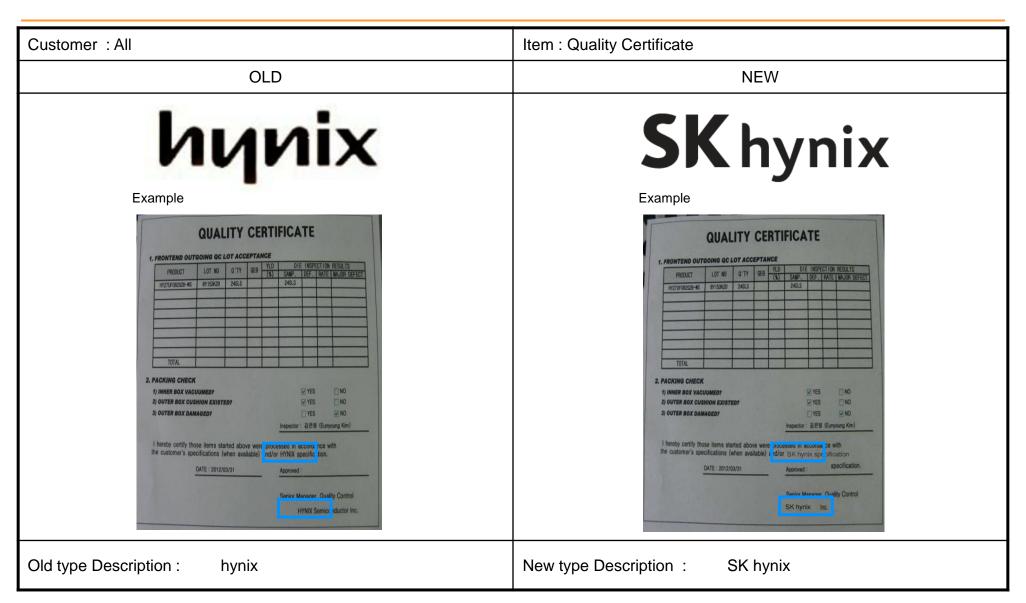


Customer : All		Item : Seal			
OLD		NEW			
hииix		<b>SK</b> hynix			
Example	2012.3.31 2012.3.31		Example QA X ACC X	SK hynix 2012, 3, 3, 1	1007 to
Old type Description :	hynix		New type Description	: SK hynix	



Customer : All	Item : Hynix, Numonyx Label
OLD	NEW
hииix	SKhynix
CUSTOMER: hynix DEVICE: ntz/uruocd2B-WS LOT NO: 8XB6L31 (1/1)  **expectation only  **aybel.31 001**  **aybel.32 001**  *	CUSTOMER: SK hymix DEVICE: http://occed2B-WS LOT NO: 8X86L31 (1/1)  **exp6L31 001**  **exp6L31 001**  **filles-007(A0-3A00A03-0A0-1028)  DATE CODE: 213A Q'TY:24 EA PACK DATE: 2012/03/31  **PACK DATE: 2012/03/31  **Manufactured unic. paces pace   pending   Printed in: SK hymix TYPE: F38Vironen  GOD DICE WFS 24  SOURCE LOT 8Y153K20 SHIPPED LOT 8X86L31  REFERENCE  **BULK ID 72E130370001  **PRINTED TO BY 15 A COUNTY 15 A COUNT
Old type Description : hynix	New type Description: SK hynix







Customer : All	Item : 출하 검사 성적서		
OLD	NEW		
hynix	<b>SK</b> hynix		
Example	Example		
호하검사 성적서  1. Customer 2. Device 3. Lot No 3. Lot No 6. 입고일자 7. 출하일자 2012년 03월 23일 7. 출하일자	호하검사 성적서  1. Customer 2. Device YACCGATSBDBS-B10A 3. Lot No 8MS0942 E02 4. Wafer 수량 12 SLS 5. 출하 Chip 수 13,472 EA 6. 입고일자 2012년 03월 23일 7. 출하일자 2012년 03월 26일		
Old type Description: hynix	New type Description: SK hynix		



